SPECIFICATION FOR LCD MODULE

ORDER NO: CG046-3007-01

MODULE NO.: CG046-3007-W-G-LED04-YG

DOC.REVISION A01

Cus	stomer Approval:		

	NAME	SIGNATURE	DATE
PREPARED BY	KOWK SHING FU		31 OCT 2007
CHECKED BY	FU SZE HOI		31 OCT 2007
APPROVED BY	FU SZE HOI		31 OCT 2007

DOCUMENT REVISION HISTORY

Version	DATE	DESCRIPTION	CHANGED BY
A00	2004 Dec 08	First Issue	
A01	2007 Oct 31	Add "RoHS Compliant" on page 2 and update outline drawing on page 1	Kowk Shing Fu

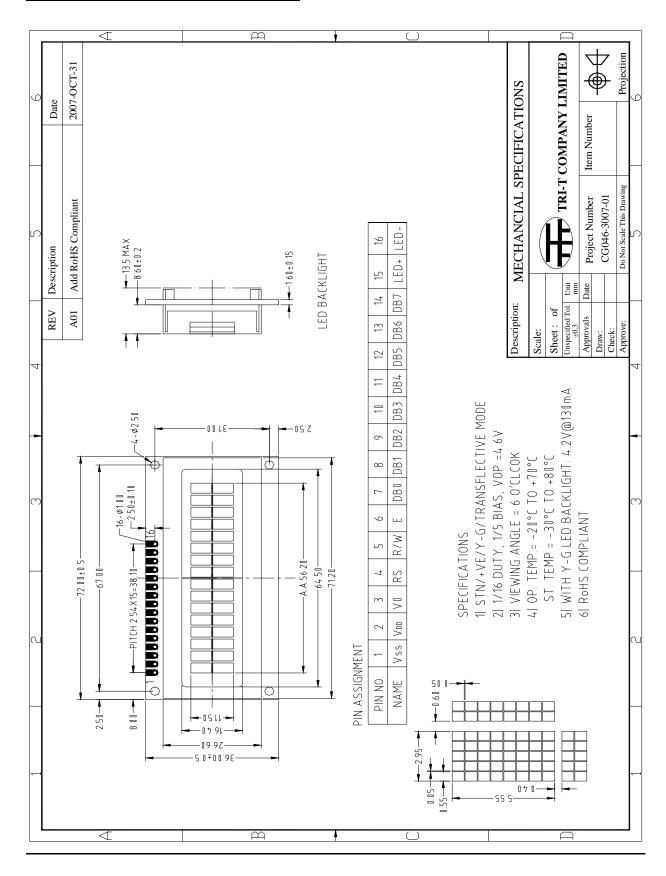


CONTENTS

Dimensional Outline	1
Functions & Features	2
Mechanical Specifications	2
Block Diagram	2
Power Supply	3
Pin Description	3
Maximum Absolute Limit	4
Electrical Characteristics	4,5,6
Backlight Specification	7
Control and Display Command	8
Standard Character Pattern	9
Relationship between DDRAM and CGRAM	10
Initializing by Instruction	11,12
Software Examples	13
Ouality Specifications	14~20



1.DIMENSIONAL OUTTINE





2.FUNCTIONS & FEATURES

2-1. Format : 16 characters*2 line

2-2. LCD mode : STN, Positive Mode (Yellow-Green)

2-3. LED Color :Yellow-Green 2-3. Viewing direction : 6 o'clock

2-4. Driving scheme : 1/16 Duty cycle, 1/5 Bias

2-5. Low power operation : Power supply voltage range (V_{DD}): 2.7~5.5V

2-6. Internal Memory : CGROM (10,880bits) : CGRAM (64*8bits)

: DDRAM (80*8bits)

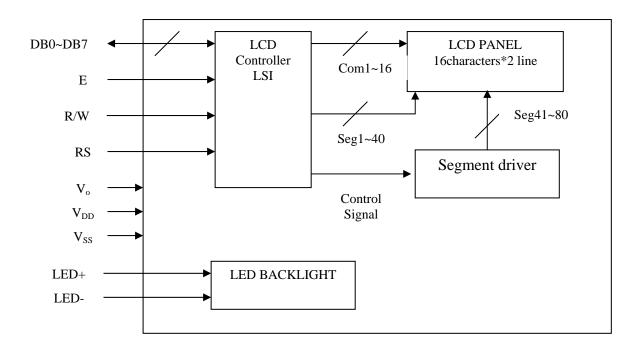
2-7. Easy interface with a 4-bit or 8-bit MPU

2-8. All materials are RoHS compliant

3.MECHANICAL SPECIFICATIONS

3-1. Module size : 72.00mm(L) x 36.00mm(W)
3-2. Viewing area : 64.50mm(L) x 16.40mm(W)
3-3. Character pitch : 5.95mm(L) x 3.55mm(W)
3-4. Character size : 5.55mm(L) x 2.95mm(W)
3-5. Dot pitch : 0.70mm(L) x 0.60mm(W)
3-6. Dot size : 0.65mm(L) x 0.55mm(W)

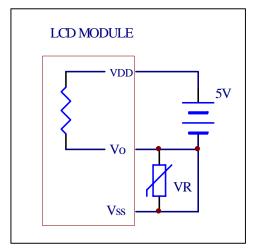
4.BLOCK DIAGRAM





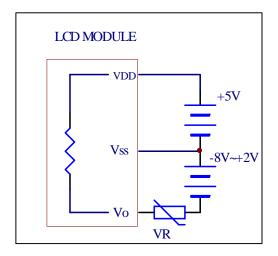
5.POWER SUPPLY

5-1.Single Power



 V_{DD} - V_0 =Operating voltage for LCD VR=10kohm~20kohm

5-2.Double Power



6. PIN DESCRIPTION

Pin no.	Symbol	Function
1	V_{SS}	Ground
2	$V_{ m DD}$	Supply voltage for logic circuit
3	V_0	Voltage level for LCD driving
4	RS	Selects register date "H" and instruction "L"
5	R/W	Use as read/write select input
6	Е	Use as read/write enable signal
7	DB0	
8	DB1	
9	DB2	Display data signal
10	DB3	DB0~DB3 are lower byte in 8-bit mode and not used
11	DB4	in 4-bit mode
12	DB5	DB4~DB7 are high byte in 4-bit/8-bit mode
13	DB6	
14	DB7	
15	LED(-)	Anode of LED backlight
16	LED(+)	Cathode of LED backlight



7.MAXIMUM ABSOUTE LIMIT (T=25°C)

Item	Symbol	Standard value	Unit
Power supply voltage for logic	$V_{ m DD}$	-0.3 ~ +7.0	V
Driver supply voltage for LCD $(V_{DD}-V_0)$	V_{LCD}	V_{DD} -12.0 ~ V_{DD} +0.3	V
Input voltage	$V_{\rm IN}$	$-0.3 \sim V_{DD} + 0.3$	V
Operating temperature	Topr	-20 ~ +70	°C
Storage temperature	Tstg	-30 ~ +80	°C

Note: Voltage greater than above may damage the module

8.ELECTRICAL CHARACTERISTICS

8-1 DC Characteristics (V_{DD} =4.5~5.5,Ta=+25°C)

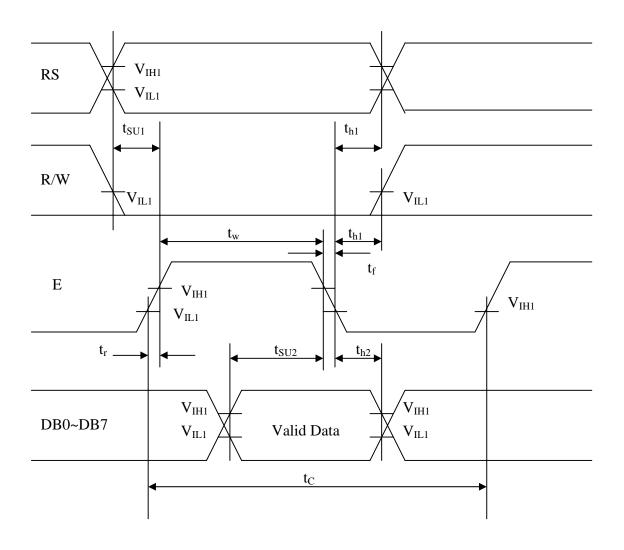
Item	Symb ol	Min	Тур	Max	Unit	Applicable terminal	Test condition
Operating voltage	V_{DD}	4.5	5	5.5	V	-	-
Supply current	I_{DD}	-	1.5	2.0	mA	-	f _{OSC=250kHZ}
Input voltage	V_{IL}	-0.3	-	0.6	V	RS,R/W	-
imput voitage	V_{IH}	2.2	-	V_{DD}	V	E,D0~D7	-
	V_{OH1}	2.4	-	$V_{ m DD}$	V	D0~D7	I _{OH} =-0.1mA
Output voltage	V _{OL1}	-	-	0.4	V	D	I _{OL} =0.1mA
output voltage	V_{OH2}	$0.9V_{DD}$	-	V_{DD}	V	CL1, CL2, M, D	I _{OH} =-40uA
	V_{OL2}	-	-	$0.1V_{DD}$	V	CE1, CE2, 111, B	I _{OL} =40uA
Input high current	I_{IH}	-2.0	-	2.0	μΑ	RS, R/W, D0~D7	V _{DD} =5V
Input low current	I_{IL}	-20	-50	-100	μΑ	RS, R/W, D0~D7	V _{DD} =5V
LCD driving voltage	V_{LCD}	4.4	4.6	4.8	V	V_{DD} - V_{0}	Ta=25°C



8-2 AC Characteristics ($V_{DD}=5V \pm 10\%$, $V_{SS}=0V$, Ta=+25°C)

8-2-1. Write mode (Writing data from MPU to LCD MODULE)

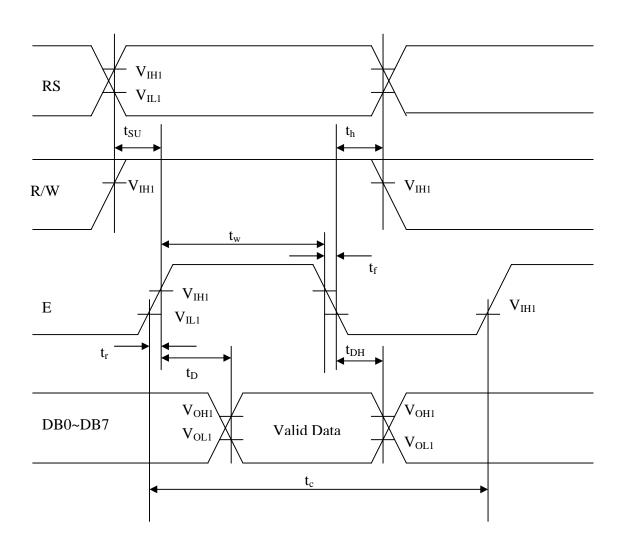
Characteristic	Symbol	Min	Тур	Max	Unit	Test pin
E cycle time	t _c	500	-	-	ns	Е
E rise time	t _r	-	-	20	ns	Е
E fall time	t_{f}	-	-	20	ns	Е
E pulse width (High, Low)	$t_{\rm w}$	230	-	-	ns	Е
R/W and RS set-up time	t_{su1}	40	-	-	ns	R/W,RS
R/W and RS hold time	t_{h1}	10	-	-	ns	R/W,RS
Data setup time	t_{su2}	80	-	-	ns	DB0~DB7
Data hold time	t _{h2}	10	=	-	ns	DB0~DB7





8-2-2. Read mode (Reading data from LCD MODULE to MPU)

Characteristic	Symbol	Min	Тур	Max	Unit	Test pin
E cycle time	t _c	500	_	_	ns	E
E rise time		300		20		E
	t _r	-	-		ns	
E fall time	t_{f}	-	-	20	ns	E
E pulse width (High, Low)	$t_{\rm w}$	230	-	-	ns	Е
R/W and RS set-up time	t_{su}	40	-	-	ns	R/W,RS, E
R/W and RS hold time	$t_{\rm h}$	10	ı	-	ns	R/W,RS, E
Data output delay	t_{D}	-	-	120	ns	DB0~DB7
Data hold time	t_{DH}	5	-	-	ns	DB0~DB7





9.BACKLIGHT SPECIFIATIONS

9-1. Absolute maximum rating

Item	Symbol	Ratings	Unit
Peak forward current	Ifp	730	mA
Reverse voltage	Vr	8	V
Power dissipation	Pd	1600	mW
Operating temperature	Topr	-20~+70	°C
Storage temperature	Tstg	-30~+80	°C

9-2. Electrical specifications

Item	Symbol	Min	Туре	Max	Unit	Conditions	
Luminous intensity	Lv	80	100	-	cd/m ²		
Peak emission wavelength	λр	-	568	-	ηm	IF=130mA	
Spectral line half width	Δλ	-	30	-	ηm	Ta=25°C	
Forward voltage	Vf	-	4.2	4.6	V		
Reverse current	Ir	-	-	1300	μΑ	VR=8V	



10.CONTROL AND DISPLAY COMMAND

Command	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Execution time (fosc=270khz)	Description		cription
Clear display	L	L	L	L	L	L	L	L	L	Н	1.52ms	set DD	Write "20H" to DDRAM ar set DDRAM address o "00H from AC	
Return home	L	L	L	L	L	L	L	L	Н	X	1.52ms	Return cursor to it's original position if shifted		
Entry mode	L	L	L	L	L	L	L	Н	I/D	SH	38μs			or move direction
set												I/D	Н	Increase
													L	Decrease
												SH:Sp	ecifies	s shift of display
												CH	Н	Displayed shifted
												SH	L	Display is not shifted
Display	L	L	L	L	L	L	Н	D	С	В	38µs	Displa		
on/off												D	H	Display on
												Cursor	L	Display off
												C	H	Cursor on Cursor off
												Blinki		Carsor on
												В	Н	Blinking on
Shift	L	L	L	L	L	Н	S/C	R/L	X	X	38µs		L H	Blinking off
Silit	L	L	L	L	L	11	3/C	K/L	Λ	Λ	30μ8	SC	L	Display shift Cursor move
													Н	Right shift
												R/L	L	Left shift
Set function	L	L	L	L	Н	DL	N	F	X	X	38μs	DL	Н	8bits interface
													L	4bits interface
												N	Н	2 lines display
													L	1 line display
												F	Н	5*10 dots
													L	5*7 dots
Set CGRAM address	L	L	L	Н	(Co		CGRAN ds to cur				38μs			a is sent and tr this setting
Set DDRAM address	L	L	Н			DDI	RAM add	dress			38μs			ta is sent and or this setting
Read busy flag &	L	Н	BF	Addı	ess cour	iter used	for both address		A & CG	RAM	0	BF		H Busy L Ready
address										-Reads BF indication internal operating is being preformed -Reads address counter contents				
Write data	Н	L		•		Write	e data				38µs	Write data into DDRAM or CGRAM		
Read data	Н	Н				Read	l data				38µs	Read data DDRAM or CGRAM		

X: Don't care



11.STANDARD CHARACTER PATTERN

Upper 4bits																
Lower 4bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)															
LLLH	(2)															
LLHL	(3)															
LLHH	(4)															
LHLL	(5)															
LHLH	(6)															
LHHL	(7)															
LHHH	(8)															
HLLL	(1)															
HLLH	(2)															
HLHL	(3)															
НЬНН	(4)															
HHLL	(5)															
HHLH	(6)															
HHHL	(7)															
нннн	(8)															



12.RELATIONSHIP BETWEEN DDRAM AND CGRAM

Ch	arac	ter (code	(DD	RAN	A da	ta)		CGI	RAM	add	lress	5			CO	FRA	M d	ata			Pattern
D7	D6	D5	D4	D3	D2	D 1	D 0	A5	A4	A3	A2	A1	A0	P7	P6	P5	P4	P3	P2	P1	P 0	number
0	0	0	0	X	0	0	0	0	0	0	0	0	0	X	X	X	1	1	1	1	1	pattern1
											0	0	1				0	0	1	0	0	
											0	1	0				0	0	1	0	0	
											0	1	1				0	0	1	0	0	
											1	0	0				0	0	1	0	0	
											1	0	1				0	0	1	0	0	
											1	1	0				0	0	1	0	0	
											1	1	1				0	0	0	0	0	
0	0	0	0	X	0	0	1	0	0	1	0	0	0	X	X	X	0	1	1	0	0	pattern2
				•					•		0	0	1		•		1	0	0	1	0	
				•					•		0	1	0		•		<u>l</u>	0	1	0	0	
				٠					•		0	1	1		•		0		0	0	0	
				•					•		1	0	0		•		1	0		0	1	1
				٠					•		1	0	1		•			0	0	1	0	-
				•					•		1	1	0		•		0	0	0	0	0	
				•					•		1	1	1		•		0	U	U	U	0	
				٠							•							•				•
				٠							•							٠				•
0	0	0	0	·	1	1	1	1	1	1	0	0	0	37	37	37	1	1	1	1	1	pattern8
0	U	U	U	Х	1	1	1	1	1	1	0	0	1	X	X	X	0	0	1	0	0	patterno
				•					•		0	1	0		•		0	0	1	0	0	
				•					•		0	1	1		•		0	0	1	0	0	
				•					•		1	0	0		•		0	0	1	0	0	
				•					•		1	0	1		•		0	0	1	0	0	
				•					•		1	1	0		•		0	0	1	0	0	
											1	1	1				0	0	0	0	0	

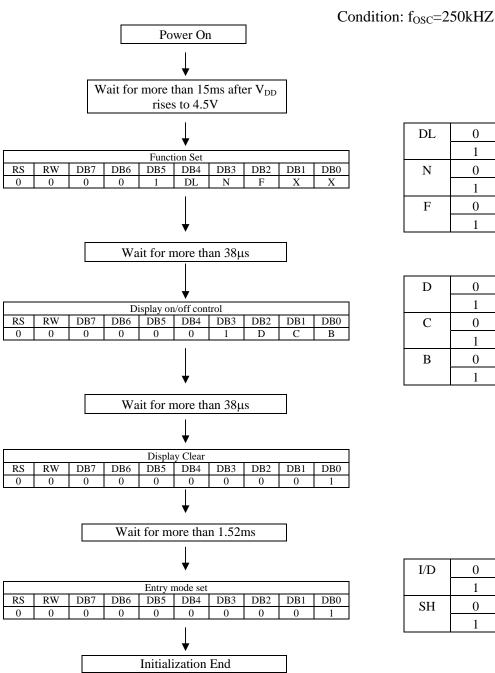
CGRAM has up to 5*8 dots 8 characters.

By writing font data to CGRAM, user defined characters can be used



13.INITIALIZING BY INSTRUCTION

13-1. 8-bit interface mode



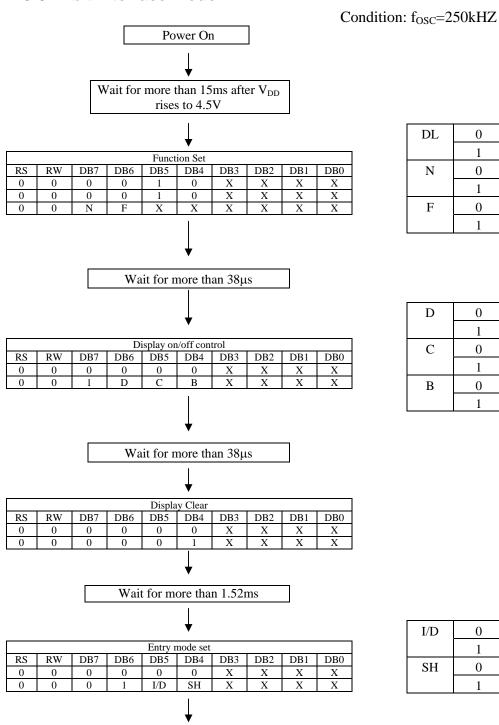
DL	0	4-bit interface					
	1	8-bit interface					
N	0	1-line mode					
	1	2-line mode					
F	0	5*7 dots					
	1	5*10 dots					

D	0	display off				
	1	display on				
С	0	cursor off				
	1	cursor on				
В	0	blink off				
	1	blink on				

I/D	0	decrement mode				
	1	increment mode				
SH	0	entire shift off				
	1	entire shift on				



13-3. 4-bit interface mode



Initialization End

DL	0	4-bit interface					
	1	8-bit interface					
N	0	1-line mode					
	1	2-line mode					
F	0	5*7 dots					
	1	5*10 dots					

D	0	display off					
	1	display on					
С	0	cursor off					
	1	cursor on					
В	0	blink off					
	1	blink on					

I/D	0	decrement mode
	1	increment mode
SH	0	entire shift off
	1	entire shift on



14. SOFTWARE EXAMPLES

1. I	Power s	upply o	on: Init	ialized	by the	intern	al pow	er on r	eset circui	t LCD DISPLAY
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
			!		ļ.			ļ		
2. I	unction	n set: 8	-bits, 2	lines.	5*7dot					
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	1	1	1	0	X	X	
	l.		<u>I</u>		l	l .	l .	<u>I</u>		
3. I	3. Display on/off control: Display On / Cursor On/ Blink Off									
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	0	0	1	1	1	0	_
			I		ı	ı	ı	I		
4. I	Entry m	ode se	t: Incre	ement						
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	0	0	0	1	1	0	-
			•		ı	ı	ı			_
5. V	Write da	ata to I	DDRAN	A: writ	te T					
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	T_
1	0	0	1	0	1	0	1	0	0	1-
	1		I		I	I	I	I		
6. V	Write da	ata to I	DDRAN	Л: writ	e R					
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	TD
1	0	0	1	0	1	0	0	1	0	TR_
	J	<u> </u>	1	J		<u> </u>	<u> </u>	1	U	
7. \	Write da	ata ta I	DDD 4 N	// xx/2024	 - _о Т					
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	TDI T
1	0	0	1	0	1	7003	1	0	0	TRI-T
	U	U		J		<u> </u>	1	U	U	
8. V	Write S	acand l	ine C	ımmor	d. 0v4	n				
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	TRI-T
0	0	1	1	0	0	0	0	0	0	1 1/1-1
U		1		U	U	U	U		U	_
9. V	Write da	ata ta I	DDDAN	/[• 337pi1	ωF					
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	TRI-T
1	0	0	1	0	1	0	1	0	0	
	U	U	1		ļ	U	1	U	U	T_
10 I	Return 1	Ното								
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	TDI T
0	0	0	0	0	0	0	0	1	X	TRI-T
U	U	U	U	U	U	U	U	1	A	TMBC
11 (Clear D	icnlow								
RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
0	0	0	0	0	0	0	0	0	1	_
			U	U	U	U	U	U	1	
A : D	X: Don't care									

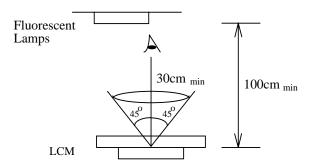


15.Quality Specifications

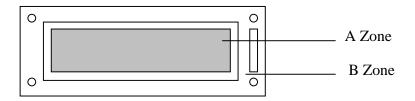
15-1. Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: Display area (LCD)

B Zone: PCB



15-2. Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Defect classification

Classify		Item	Note	AQL
Major	Display	Short or open circuit	1	0.65
	state	Contrast defect (dim, ghost)		
		LC leakage		
		Flickering		
		No display		
		Wrong viewing direction	2	
		Wrong Back-light	7	
Non-display		Flat cable or pin reverse	9	
		Wrong or missing component	10	
Minor	Display	Background color deviation	2	1.5
	state	Black spot and dust	3	
		Line defect	4	
		Scratch		
		Rainbow	5	
		Pin hole	6	
	Polarizer	Bubble and foreign material	3	
		Scratch	4	
	PCB	Scratch	4	
	Soldering	Poor connection	8	
	Wire	Poor connection	9	



Note on defect classification

No.	Item			Cı	riterion		
1	Short or open circuit			No	ot allow		
	LC leakage						
	Flickering						
	No display						
	Wrong viewing direction						
	Wrong Back-light						
2	Contrast defect		Refe	r to a	pproval san	nple	
	Background color deviation						
3	Point defect, Black spot, dust (incl. Polarizer) $\phi = (X+Y)/2$	$\bigvee_{\widehat{X}} Y$	Unit	0.10 0.20 0.25	Point Size $\phi \le 0.10$ $0 < \phi \le 0.20$ $0 < \phi \le 0.25$ $0 < \phi \le 0.30$ $0 < \phi \le 0.30$	Acceptable Qty. Disregard 3 2 1 0	
4	Line defect	$ \begin{array}{c} \downarrow \\ \uparrow \\ \downarrow \\ \downarrow \\ L \end{array} $	L 3.0≥ 2.0≥ 1.0≥	0.0 L ()	ine W 015≥W 0.03≥W 0.05≥W 0.1>W 0.05 <w< td=""><td>Acceptable Qty. Disregard 2 1 Applied as point defect</td></w<>	Acceptable Qty. Disregard 2 1 Applied as point defect	
5	Rainbow	Unit: mm Not more than two color changes across the viewing area.					



No.	Item	Criterion
6	Segment pattern $W = \text{Segment width}$ $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10 \text{mm is acceptable.}$ X Y
		Unit: mm
7	Back-light	(1) The color of backlight should correspond its specification.(2) Not allow flickering
8	Soldering	(1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. Lead Land 50% lead
9	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable.
10	PCB	(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.



15-3. Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	80°C	240	
High temp. Operating	70°C	240	No abnormalities in functions and appearance
Low temp. Storage	-30°C	240	
Low temp. Operating	-20°C	240	
Humidity	40°C/ 90%RH	240	
Temp. Cycle	-30°C ← 25°C →80°C	10cycles	
	$(30 \min \leftarrow 5 \min \rightarrow 30 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}$ C), normal humidity (below 65% RH), and in the area not exposed to direct sun light.



15-4. Precaution for using LCM

LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting TRI-T.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.



Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: 280°C±10°C
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.

Operation Precautions:

- 1. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 2. For long-term storage over 40°C is required, the relative humidity should be kept below 60%. Avoid direct sunlight.

Limited Warranty

TRI-T modules are not consumer products, but may be incorporated by TRI-T's customers into consumer products or components thereof, TRI-T does not warrant that its modules and components are fit for any such particular purpose.

- 1. The liability of TRI-T is limited to repair or replacement on the terms set forth below. TRI-T will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between TRI-T and the customer, TRI-T will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with TRI-T QUALITY INSPECTION STANDARD.
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCM, they must be properly packaged; there should be detailed description of the failures or defect.